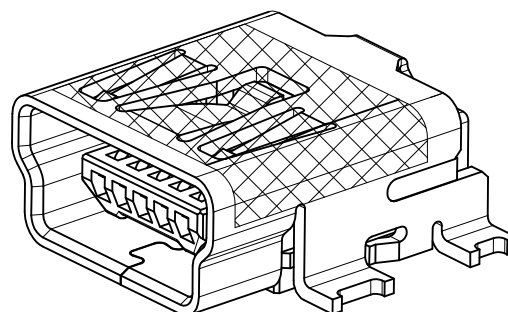
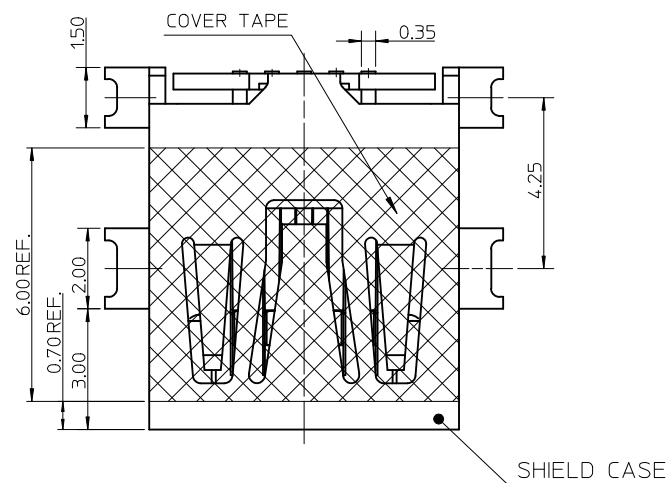
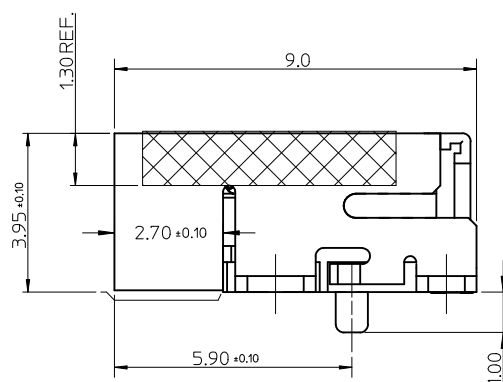
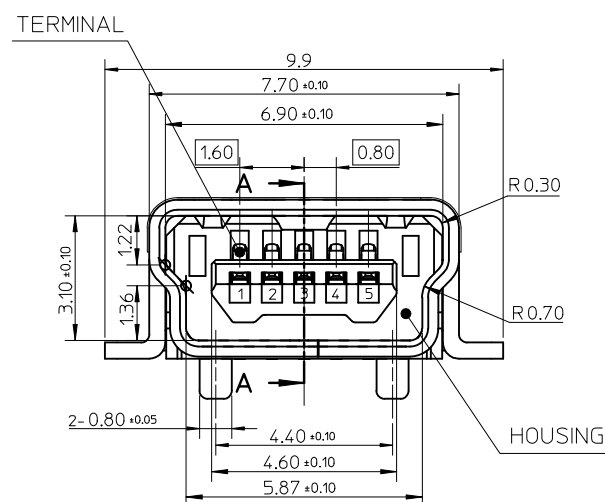


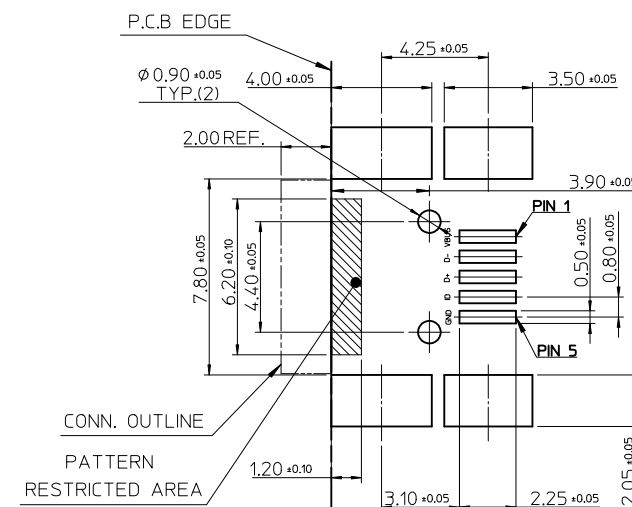


NOTE :

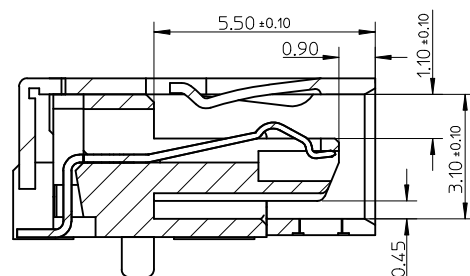
1. MATERIAL :
HOUSING : HIGH TEMPERATURE THERMAL PLASTIC ,
BLACK,UL94V-0
TERMINAL : COPPER ALLOY THICKNESS = 0.2 MM
SHIELD CASE : COPPER ALLOY THICKNESS = 0.4 MM
2. PLATING :
TERMINAL:
CONTACT AREA : GOLD 0.75 MICROMETER MINIMUM.
SOLDER TAIL AREA :PURE TIN 1~3 MICROMETER PLATING.
UNDER PLATING : NICKEL 1.25 MICROMETER MINIMUM.
SHIELD CASE :
PURE TIN 1~3 MICROMETER PLATING.
UNDER PLATING : NICKEL 1.0 MICROMETER MINIMUM.
3. TAIL & NAIL COPLANARITY 0.1 mm MAXIMUM.
4. PRODUCT SPECIFICATION REFER TO PS-67803-001.
5. PACKAGING INFORMATION REFER TO PK-67503-001.
6. COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV
DIRECTIVE 2000/53/EC.



PRODUCT NO.	REMARK
67503-1020	N/A
67503-1120	HALOGEN FREE



RECOMMENDED P.C.B. PATTERN LAYOUT



SECTION A-A

REMOVE PART NUMBER		EC NO: SH2012-0143		2011/11/16		2011/11/16		2011/11/21		DESCRIPTION		QUALITY SYMBOLS		GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 8:1		DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	
												$\nabla_F=0$		4 PLACES		DRAWN BY LXWANG		DATE 2004/11/29		TITLE USB SERIES MINI-B REC. ASS'Y SMT TYPE (LEAD FREE) MOLEX MOLEX INCORPORATED DOCUMENT NO. SD-67503-010			
												$\nabla_G=0$		3 PLACES		CHECKED BY HARVEY		DATE 2004/11/29					
												$\nabla_P=0$		2 PLACES		APPROVED BY YTYAP		DATE 2004/11/29					
														1 PLACE									
														ANGULAR $\pm 3^\circ$		MATERIAL NO.						SHEET NO. 1 OF 1	
														DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE							
																SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					